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(Contributors from January 1–December 31, 1998)

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All member companies of the National Association of Metal Finishers and the Metal Finishing Suppliers Association contribute a portion of their dues to the joint government relations program.

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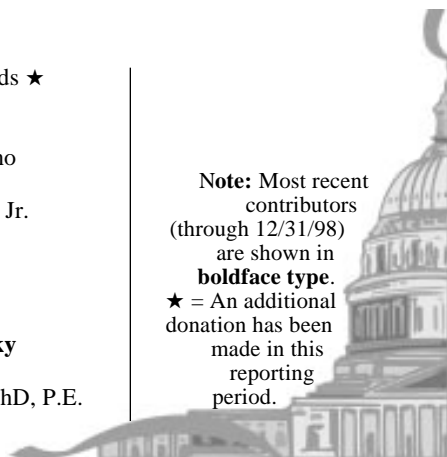
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CSL, Inc.  
Cuevas Dennis Corp.  
DB Metal Finishing Corp.  
DCI Industries, Inc.  
Delta Chemicals & Equipment, Inc.

**Note:** Most recent contributors (through 12/31/98) are shown in **boldface type**. ★ = An additional donation has been made in this reporting period.



Delta Faucet Co.  
**Deveco Corporation**  
Eagle Plating Service, Inc.  
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**SWD, Inc.**  
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 Ultra Plating Corp.  
 Valentine Plating  
 Waukesha Metal Finishing, Inc.  
 West Coast Rack & Mfg., Inc.

Question #1:  
*What does our Government Relations Program do?*

Answers:

1. It saves the finishing industry millions of dollars a year.
2. It offers a technical resource to government agencies.
3. It gives the finishing industry a visibility that is necessary in today's times.
4. It's a multifaceted program, covering:
  - Water quality issues
  - Air quality issues
  - Hazardous waste & Superfund issues
  - Environmental & pollution prevention technologies
  - TRI reporting
  - International activities

Question #2:  
*How is the Government Relations Program funded?*

Answer:  
 By contributions from companies, groups & individuals. Help secure the industry's future.

*Contributions/pledges are encouraged. Please complete the form below and send it, with your pledge or contribution, to: Government Relations Program, c/o AESF Headquarters, 12644 Research Pkwy., Orlando, FL 32826-3298.*

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(11.9Ω/sq). The new direct metallization technology can be offered to manufacturers of Ni-Co film-coated polyimide substrate. This process will provide high reliability because no adhesive layer exists between the polyimide and the Ni-Co alloy deposits. Further development of this process can also extend its application beyond FPC, TAB and build-up technology.

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